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FDMA1027P

Dual P-Channel PowerTrench[®] MOSFET

General Description

This device is designed specifically as a single package solution for the battery charge switch in cellular handset and other ultra-portable applications. It features two independent P-Channel MOSFETs with low on-state resistance for minimum conduction losses. When connected in the typical common source configuration, bi-directional current flow is possible.

The MicroFET 2x2 package offers exceptional thermal performance for it's physical size and is well suited to linear mode applications.

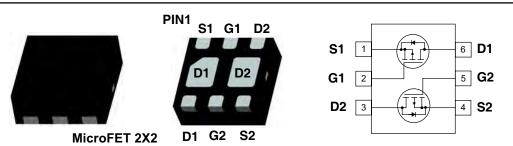


July 2014

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Features

- -3.0 A, -20V. $R_{DS(ON)} = 120 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$ $R_{DS(ON)} = 160 \text{ m}\Omega @ V_{GS} = -2.5 \text{ V}$ $R_{DS(ON)} = 240 \text{ m}\Omega @ V_{GS} = -1.8 \text{ V}$
- Low Profile 0.8 mm maximun in the new package MicroFET 2x2 mm
- RoHS Compliant
- Free from halogenated compounds and antimony oxides



Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	MOSFET Drain-Source Voltage		-20	V
V _{GSS}	MOSFET Gate-Source Voltage		±8	V
I _D	Drain Current -Continuous	(Note 1a)	-3.0	A
	-Pulsed		-6	
P _D	Power dissipation	(Note 1a)	1.4	
		(Note 1b)	0.7	
		(Note 1c)	1.8	— w
		(Note 1d)	0.8	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance for Single Operation, Junction-to-Ambient	(Note 1a)	86	
$R_{\theta JA}$	Thermal Resistance for Single Operation, Junction-to-Ambient	(Note 1b)	173	°C/W
$R_{\theta JA}$	Thermal Resistance for Dual Operation, Junction-to-Ambient	(Note 1c)	69	10/10
$R_{\theta JA}$	Thermal Resistance for Dual Operation, Junction-to-Ambient	(Note 1d)	151	

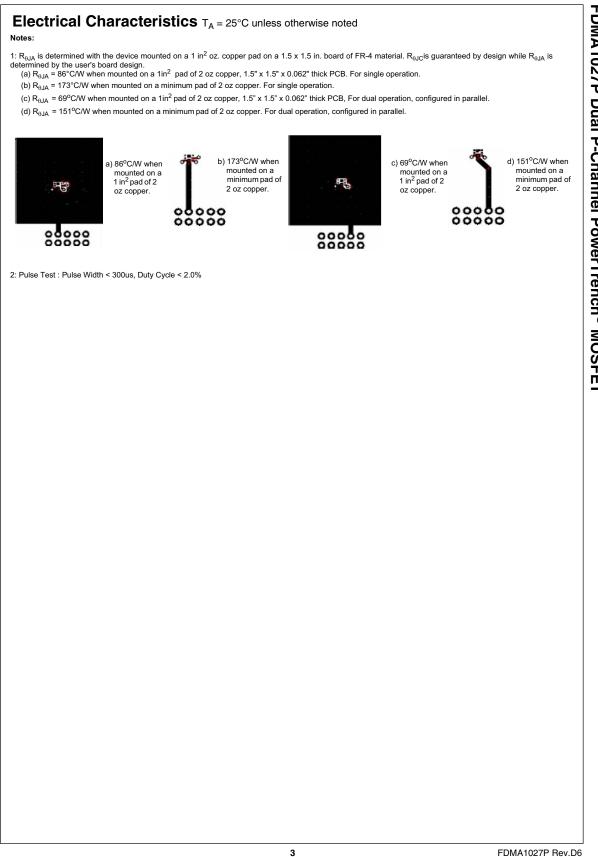
Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
027	FDMA1027P	7"	8mm	3000 units

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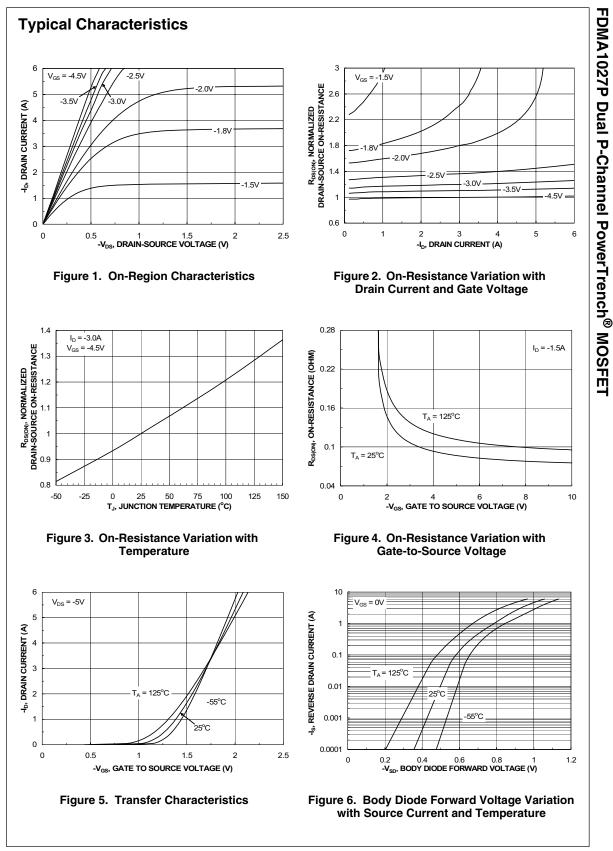
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = -250μA	-20	_	-	V
∆BV _{DSS}	Breakdown Voltage Temperature	$I_{\rm D} = -250 \mu {\rm A},$				-
ΔT_J	Coefficient	Referenced to 25°C	-	-12	-	mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = -16V, V_{GS} = 0V$	-	-	-1	μA
I _{GSS}	Gate-Body Leakage,	$V_{GS} = \pm 8V, V_{DS} = 0V$	-	-	±100	nA
On Chara	cteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-0.4	-0.7	-1.3	V
$\Delta V_{GS(th)}$	Gate Threshold Voltage	$I_{\rm D} = -250 \mu A,$		0		
ΔT_J	Temperature Coefficient	Referenced to 25°C	-	2	-	mV/°C
		$V_{GS} = -4.5V, I_D = -3.0A$	-	90	120	
		$V_{GS} = -2.5V, I_D = -2.5A$	-	120	160	
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = -1.8V, I_D = -1.0A$	-	172	240	mΩ
		$V_{GS} = -4.5V, I_D = -3.0A$ $T_J = 125^{\circ}C$	-	118	160	
I _{D(on)}	On-State Drain Current	$V_{GS} = -4.5V, V_{DS} = -5V$	-20	-	-	A
9 _{FS}	Forward Transconductance	$V_{DS} = -5V, I_D = -3.0A$	-	7	-	S
Dvnamic	Characteristics	•				
C _{iss}	Input Capacitance		-	435	-	pF
C _{oss}	Output Capacitance	$-V_{DS} = -10V, V_{GS} = 0V,$	-	80	-	pF
C _{rss}	Reverse Transfer Capacitance	f = 1.0MHz	-	45	-	pF
			-	9	18	ns ns
	Turn-On Delay Time Turn-On Rise Time	$-1_{V_{DD}}10_{V_{DD}}14_{V_{DD}}$	-	11	19	
t _{d(on)} t _r td(off)	Turn-On Rise Time	$V_{DD} = -10V, I_D = -1A$ $V_{GS} = -4.5V, R_{GEN} = 6\Omega$	-	11 15	19 27	
t _r t _{d(off)}	Turn-On Rise Time Turn-Off Delay Time	$V_{DD} = -10V, I_D = -1A$ $V_{GS} = -4.5V, R_{GEN} = 6\Omega$		11 15 6	19 27 12	ns
t _r t _{d(off)} t _f	Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$	-	15	27	
t _r t _{d(off)} t _f Q _g	Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$ $V_{DS} = -10V, I_D = -3.0A,$	-	15 6	27 12	ns ns
t _r t _{d(off)} t _f Q _g Q _{gs}	Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$	-	15 6 4	27 12 6	ns ns nC
t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd}	Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$ $V_{DS} = -10V, I_D = -3.0A, V_{GS} = -4.5V$	-	15 6 4 0.8	27 12 6	ns ns nC nC
t _r t _{d(off)} t _f Q _g Q _{gd} Drain-Sou	Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$ $V_{DS} = -10V, I_D = -3.0A,$ $V_{GS} = -4.5V$ Maximum Ratings	-	15 6 4 0.8	27 12 6	ns ns nC nC
t _r t _{d(off)} t _f Q _g Q _{gd} Drain-Sou I _S	Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge urce Diode Characteristics and	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$ $V_{DS} = -10V, I_D = -3.0A,$ $V_{GS} = -4.5V$ Maximum Ratings de Forward Current	-	15 6 4 0.8	27 12 6 -	ns ns nC nC nC
t _r t _{d(off)} t _f Q _g Q _{gd} Drain-Sou	Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge urce Diode Characteristics and Maximum Continuous Drain-Source Dio	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$ $V_{DS} = -10V, I_D = -3.0A,$ $V_{GS} = -4.5V$ Maximum Ratings	- - - - - -	15 6 4 0.8 0.9	27 12 6 - -	ns ns nC nC nC

FDMA1027P Rev.D6



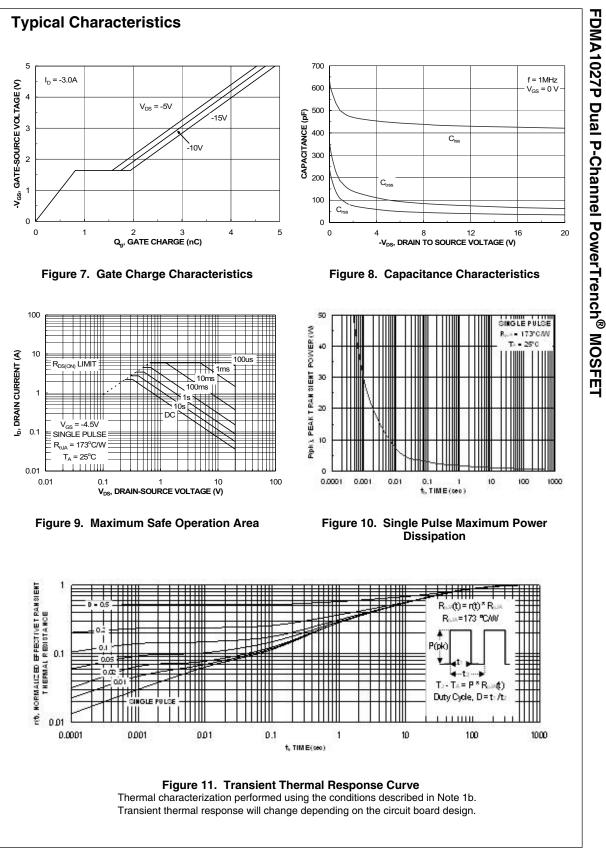
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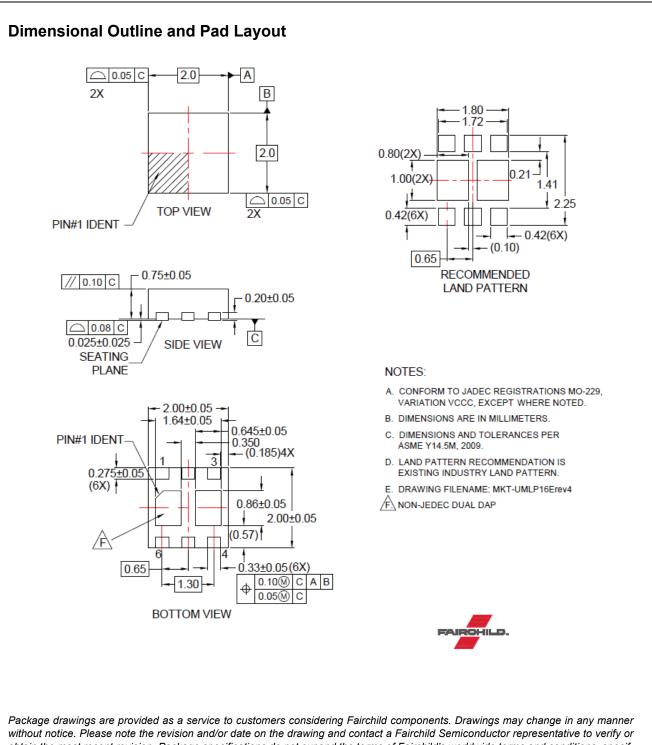


FDMA1027P Rev. D6

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FDMA1027P Rev. D6



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http://www.fairchildsemi.com/package/packageDetails.html?id=PN_MLDEB-X06



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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
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